

L Number	Hits	Search Text	DB	Time stamp
1	2234	(257/59,72).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/14 13:15
2	3014	(349/42,43,187).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/14 13:16
3	31889	thermal\$3-treat\$3 (thermal\$3 near5 treat\$3) thermal\$3 adj treat\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/14 13:16
4	26262	(alignment aliging orientation orienting) adj (layer film)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/14 13:17
5	1607944	simultaneous\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/14 13:17
6	2	(thermal\$3-treat\$3 (thermal\$3 near5 treat\$3) thermal\$3 adj treat\$3) same ((alignment aliging orientation orienting) adj (layer film)) same simultaneous\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/14 13:19
7	55667	(source drain) adj electrode	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/14 13:19
8	224005	heat\$3 adj treatment	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/14 13:20
9	3843575	heat\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/14 13:20
10	1722712	cur\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/14 13:20
11	4999721	heat\$3 cur\$3 (heat\$3 adj treatment) (thermal\$3-treat\$3 (thermal\$3 near5 treat\$3) thermal\$3 adj treat\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/14 13:21
12	1	(heat\$3 cur\$3 (heat\$3 adj treatment) (thermal\$3-treat\$3 (thermal\$3 near5 treat\$3) thermal\$3 adj treat\$3)) near10 ((alignment aliging orientation orienting) adj (layer film)) near10 ((source drain) adj electrode)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/14 13:22

13	25	((heat\$3 cur\$3 (heat\$3 adj treatment) (thermal\$3-treat\$3 (thermal\$3 near5 treat\$3) thermal\$3 adj treat\$3)) same ((alignment aliging orientation orienting) adj (layer film)) same ((source drain) adj electrode)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/14 13:23
15	8	((349/42,43,187).ccls.) and ((heat\$3 cur\$3 (heat\$3 adj treatment) (thermal\$3-treat\$3 (thermal\$3 near5 treat\$3) thermal\$3 adj treat\$3)) same ((alignment aliging orientation orienting) adj (layer film)) same ((source drain) adj electrode))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/14 13:23
14	3	((257/59,72).ccls.) and ((heat\$3 cur\$3 (heat\$3 adj treatment) (thermal\$3-treat\$3 (thermal\$3 near5 treat\$3) thermal\$3 adj treat\$3)) same ((alignment aliging orientation orienting) adj (layer film)) same ((source drain) adj electrode))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/14 13:24
16	135025	(active semiconductor) adj (layer film)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/14 13:25
17	56991	ohmic	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/14 13:25
18	1524167	pattern\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/14 13:25
19	436865	mask	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/14 13:25
20	121	((active semiconductor) adj (layer film)) near10 ohmic near10 pattern\$3 near10 mask	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/14 13:26
21	16	simultaneous\$3 near10 (((active semiconductor) adj (layer film)) near10 ohmic near10 pattern\$3 near10 mask)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/14 13:29
22	1	simultaneous\$3 near10 ((source drain) adj electrode) near10 ((alignment aliging orientation orienting) adj (layer film))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/14 13:30
23	81420	simultaneous\$3 near10 (heat\$3 cur\$3 (heat\$3 adj treatment) (thermal\$3-treat\$3 (thermal\$3 near5 treat\$3) thermal\$3 adj treat\$3))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/14 13:31
25	0	((simultaneous\$3 near10 (heat\$3 cur\$3 (heat\$3 adj treatment) (thermal\$3-treat\$3 (thermal\$3 near5 treat\$3) thermal\$3 adj treat\$3))) near10 ((alignment aliging orientation orienting) adj (layer film))) near10 ((source drain) adj electrode)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/14 13:31

24	22	(simultaneous\$3 near10 (heat\$3 cur\$3 (heat\$3 adj treatment) (thermal\$3-treat\$3 (thermal\$3 near5 treat\$3) thermal\$3 adj treat\$3))) near10 ((alignment aliging orientation orienting) adj (layer film))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/14 13:33
26	152939	annealing	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/14 13:34
27	1	simultaneous\$3 near10 (heat\$3 cur\$3 (heat\$3 adj treatment) (thermal\$3-treat\$3 (thermal\$3 near5 treat\$3) thermal\$3 adj treat\$3)) near10 ((alignment aliging orientation orienting) adj (layer film)) near10 annealing	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/14 13:34
28	2	simultaneous\$3 same (heat\$3 cur\$3 (heat\$3 adj treatment) (thermal\$3-treat\$3 (thermal\$3 near5 treat\$3) thermal\$3 adj treat\$3)) same ((alignment aliging orientation orienting) adj (layer film)) same annealing	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/14 13:35